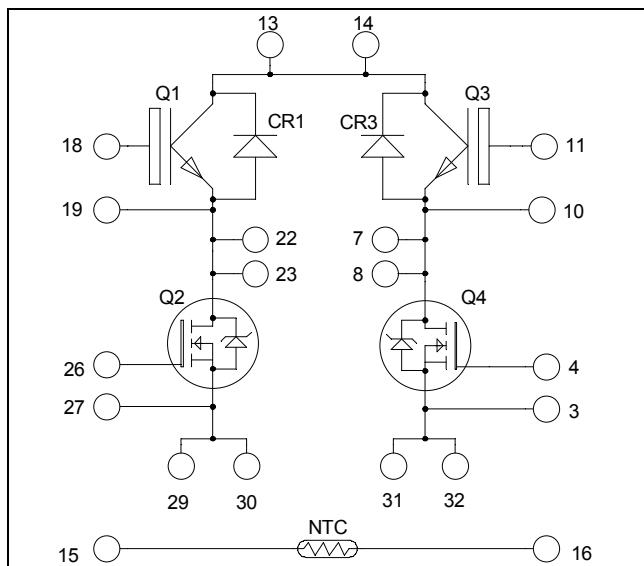


**Full - Bridge
NPT & Trench + Field Stop® IGBT
Power module**

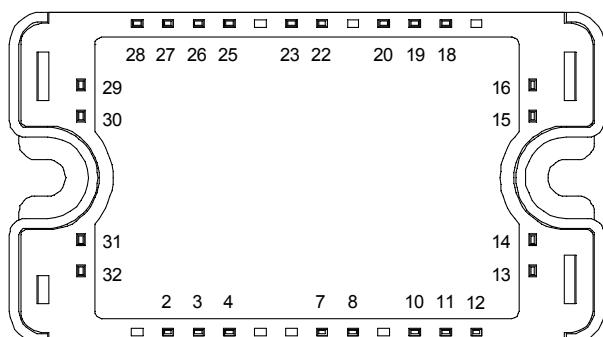
Trench & Field Stop® IGBT Q1, Q3:
 $V_{CES} = 600V$; $I_C = 50A$ @ $T_c = 80^\circ C$

CoolMOS™ Q2, Q4:
 $V_{CES} = 600V$; $I_C = 49A$ @ $T_c = 25^\circ C$



Top switches : Trench + Field Stop IGBT®

Bottom switches : CoolMOS™



All multiple inputs and outputs must be shorted together
 13/14 ; 15/16 ; 26/27 ; 31/32

Application

- Solar converter

Features

- **Q_2, Q_4 CoolMOS™**
 - Ultra low R_{DSon}
 - Low Miller capacitance
 - Ultra low gate charge
 - Avalanche energy rated
- **Q_1, Q_3 Trench & Field Stop IGBT®**
 - Low voltage drop
 - Switching frequency up to 20 kHz
 - RBSOA & SCSOA rated
 - Low tail current

- Kelvin emitter for easy drive
- Very low stray inductance
- High level of integration
- Internal thermistor for temperature monitoring

Benefits

- Optimized conduction & switching losses
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Easy paralleling due to positive T_c of V_{CEsat}
- RoHS Compliant

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

1. Top switches

1.1 Top Trench + Field Stop IGBT® characteristics

Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage		600	V
I_C	Continuous Collector Current	$T_C = 25^\circ\text{C}$	80	A
		$T_C = 80^\circ\text{C}$	50	
I_{CM}	Pulsed Collector Current	$T_C = 25^\circ\text{C}$	100	
V_{GE}	Gate – Emitter Voltage		± 20	V
P_D	Maximum Power Dissipation	$T_C = 25^\circ\text{C}$	176	W
RBSOA	Reverse Bias Safe Operating Area	$T_J = 150^\circ\text{C}$	100A @ 550V	

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0\text{V}$, $V_{CE} = 600\text{V}$			250	μA
$V_{CE(\text{sat})}$	Collector Emitter Saturation Voltage	$V_{GE} = 15\text{V}$	$T_J = 25^\circ\text{C}$	1.5	1.9	V
		$I_C = 50\text{A}$	$T_J = 150^\circ\text{C}$	1.7		
$V_{GE(\text{th})}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 600\mu\text{A}$	5.0	5.8	6.5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20\text{V}$, $V_{CE} = 0\text{V}$			600	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0\text{V}$ $V_{CE} = 25\text{V}$ $f = 1\text{MHz}$		3150		pF
C_{oes}	Output Capacitance			200		
C_{res}	Reverse Transfer Capacitance			95		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C) $V_{GE} = \pm 15\text{V}$ $V_{Bus} = 300\text{V}$ $I_C = 50\text{A}$ $R_G = 8.2\Omega$		110		ns
T_r	Rise Time			45		
$T_{d(off)}$	Turn-off Delay Time			200		
T_f	Fall Time			40		
$T_{d(on)}$	Turn-on Delay Time			120		ns
T_r	Rise Time	$V_{GE} = \pm 15\text{V}$ $V_{Bus} = 300\text{V}$ $I_C = 50\text{A}$ $R_G = 8.2\Omega$		50		
$T_{d(off)}$	Turn-off Delay Time			250		
T_f	Fall Time			60		
E_{on}	Turn-on Switching Energy	$V_{GE} = \pm 15\text{V}$	$T_j = 25^\circ\text{C}$	0.3		mJ
		$V_{Bus} = 300\text{V}$	$T_j = 150^\circ\text{C}$	0.43		
E_{off}	Turn-off Switching Energy	$I_C = 50\text{A}$	$T_j = 25^\circ\text{C}$	1.35		mJ
		$R_G = 8.2\Omega$	$T_j = 150^\circ\text{C}$	1.75		
R_{thJC}	Junction to Case Thermal resistance				0.85	$^\circ\text{C}/\text{W}$

1.2 Top fast diode characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V _{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V
I _{RM}	Maximum Reverse Leakage Current	V _R =600V	T _j = 25°C			25	μA
			T _j = 125°C			500	
I _F	DC Forward Current		T _c = 80°C		30		A
V _F	Diode Forward Voltage	I _F = 30A			1.8	2.3	V
		I _F = 60A			2.1		
		I _F = 30A	T _j = 125°C		1.5		
t _{rr}	Reverse Recovery Time	I _F = 30A V _R = 400V di/dt = 200A/μs	T _j = 25°C		25		ns
			T _j = 125°C		160		
Q _{rr}	Reverse Recovery Charge	I _F = 30A V _R = 400V di/dt = 200A/μs	T _j = 25°C		35		nC
			T _j = 125°C		480		
R _{thJC}	Junction to Case Thermal resistance					1.2	°C/W

2. Bottom switches

2.1 Bottom CoolMOS™ characteristics

Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V _{DSS}	Drain - Source Breakdown Voltage		600	V
I _D	Continuous Drain Current	T _c = 25°C	49	A
		T _c = 80°C	38	
I _{DM}	Pulsed Drain current		130	
V _{GS}	Gate - Source Voltage		±20	V
R _{DS(on)}	Drain - Source ON Resistance		45	mΩ
P _D	Maximum Power Dissipation	T _c = 25°C	290	W
I _{AR}	Avalanche current (repetitive and non repetitive)		15	A
E _{AR}	Repetitive Avalanche Energy		3	mJ
E _{AS}	Single Pulse Avalanche Energy		1900	

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0V, V _{DS} = 600V	T _j = 25°C			250	μA
		V _{GS} = 0V, V _{DS} = 600V	T _j = 125°C			500	
R _{DS(on)}	Drain – Source on Resistance	V _{GS} = 10V, I _D = 24.5A			40	45	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} = V _{DS} , I _D = 3mA		2.1	3	3.9	V
I _{GSS}	Gate – Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0V				100	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C _{iss}	Input Capacitance	V _{GS} = 0V ; V _{DS} = 25V f = 1MHz		7.2		nF
C _{rss}	Reverse Transfer Capacitance			0.29		
Q _g	Total gate Charge	V _{GS} = 10V V _{Bus} = 300V I _D = 49A		150		nC
Q _{gs}	Gate – Source Charge			34		
Q _{gd}	Gate – Drain Charge			51		
T _{d(on)}	Turn-on Delay Time	Inductive Switching (125°C) V _{GS} = 10V V _{Bus} = 400V I _D = 49A R _G = 4.7Ω		21		ns
T _r	Rise Time			30		
T _{d(off)}	Turn-off Delay Time			100		
T _f	Fall Time			45		
E _{on}	Turn-on Switching Energy	Inductive switching @ 25°C V _{GS} = 10V ; V _{Bus} = 400V I _D = 49A ; R _G = 4.7Ω		675		μJ
E _{off}	Turn-off Switching Energy			520		
E _{on}	Turn-on Switching Energy	Inductive switching @ 125°C V _{GS} = 10V ; V _{Bus} = 400V I _D = 49A ; R _G = 4.7Ω		1100		μJ
E _{off}	Turn-off Switching Energy			635		
R _{thJC}	Junction to Case Thermal resistance				0.5	°C/W

3. Temperature sensor

NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic	Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C		50		kΩ
B _{25/85}	T ₂₅ = 298.15 K		3952		K

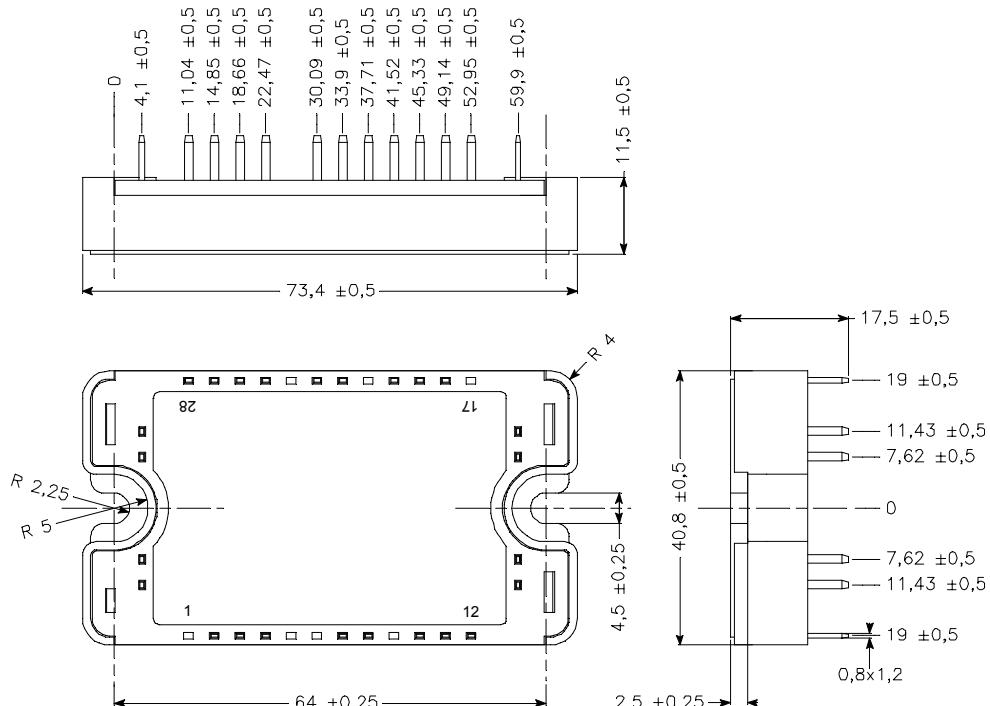
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad T: \text{Thermistor temperature} \\ R_T: \text{Thermistor value at } T$$

4. Package characteristics

Symbol	Characteristic	Min	Typ	Max	Unit	
V _{ISOL}	RMS Isolation Voltage, any terminal to case t=1 min, I isol<1mA, 50/60Hz	2500			V	
T _J	Operating junction temperature range	-40		150*	°C	
T _{STG}	Storage Temperature Range	-40		125		
T _C	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M4	2.5	4.7	N.m
Wt	Package Weight			110	g	

 T_j=175°C for Trench & Field Stop IGBT

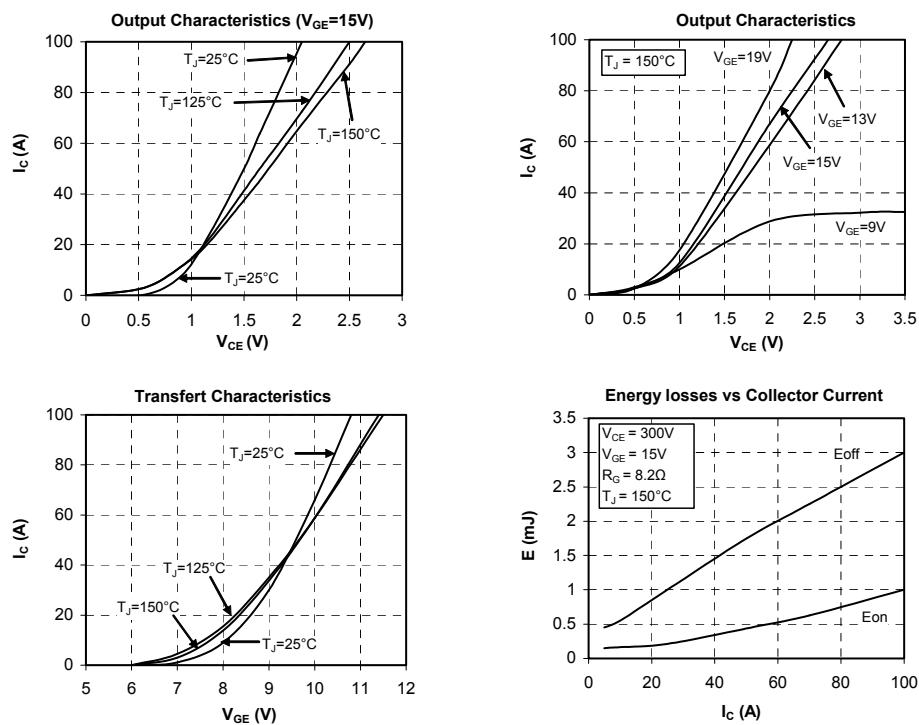
5. SP3 Package outline (dimensions in mm)

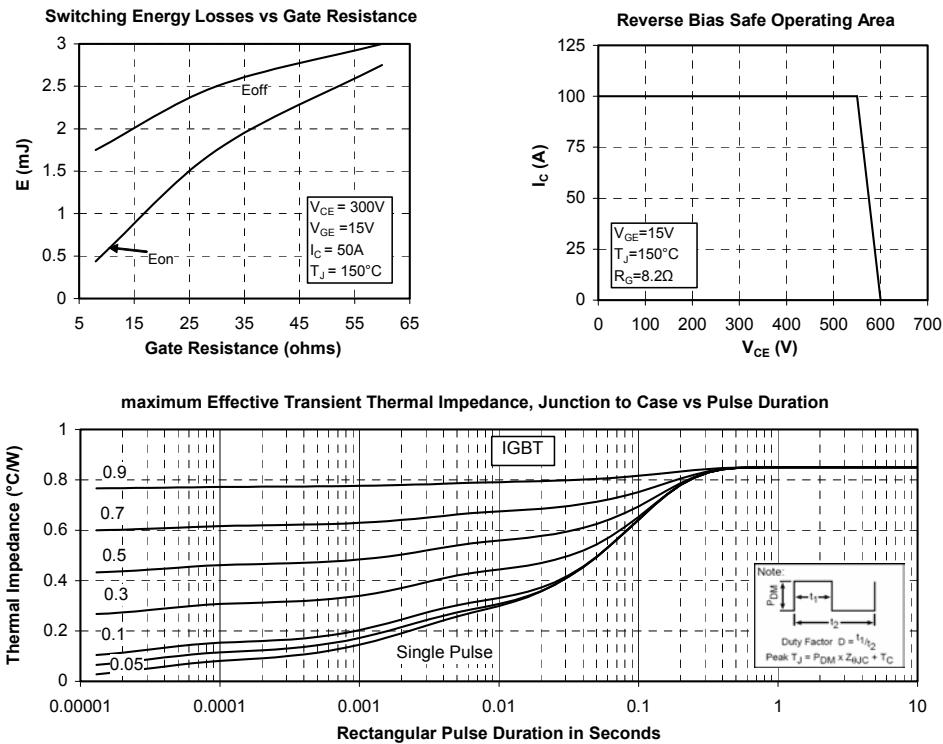


See application note 1901 - Mounting Instructions for SP3 Power Modules on www.microsemi.com

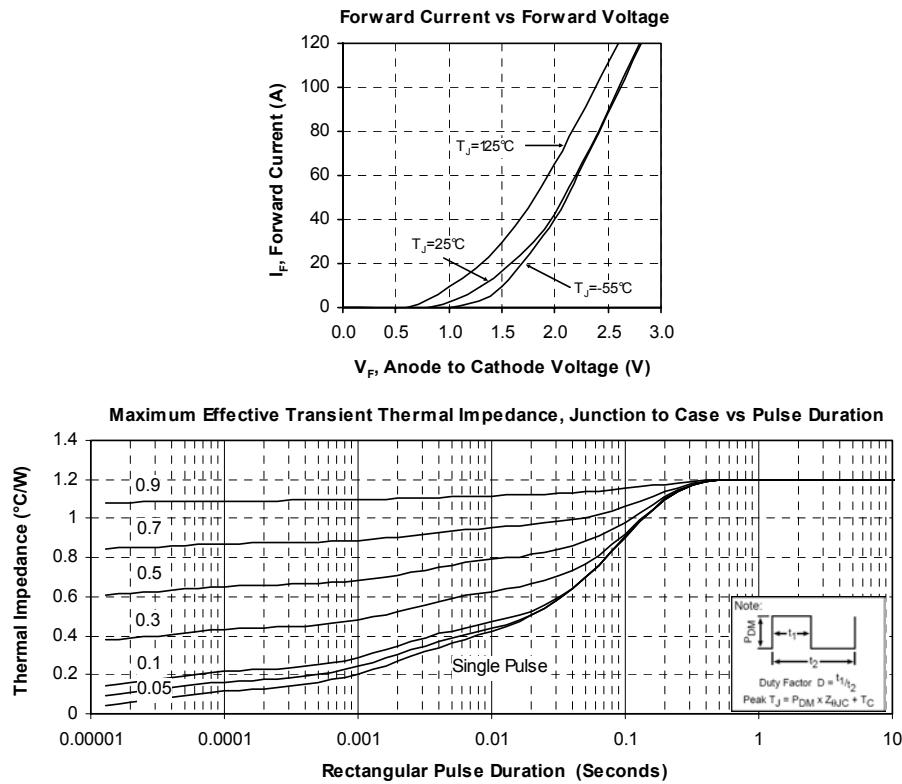
6. Top switches curves

6.1 Top Trench + Field Stop IGBT® typical performance curves



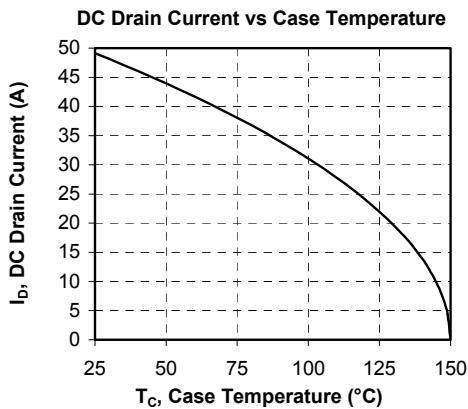
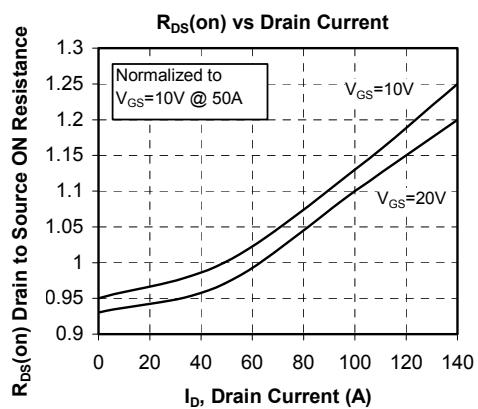
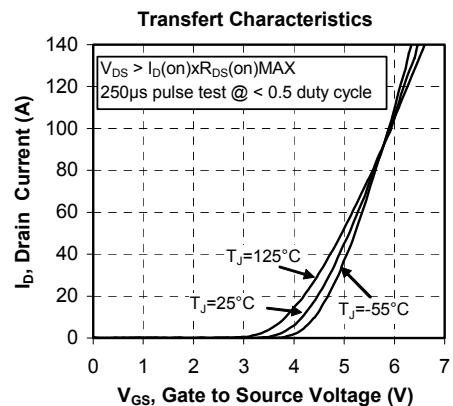
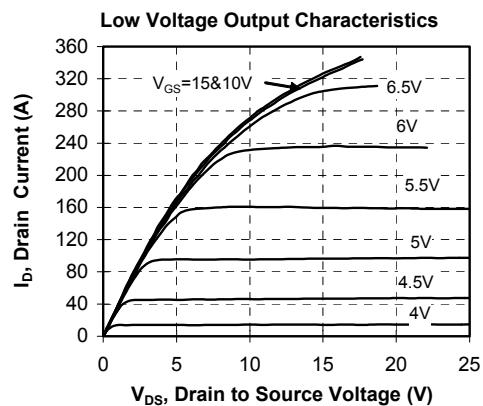
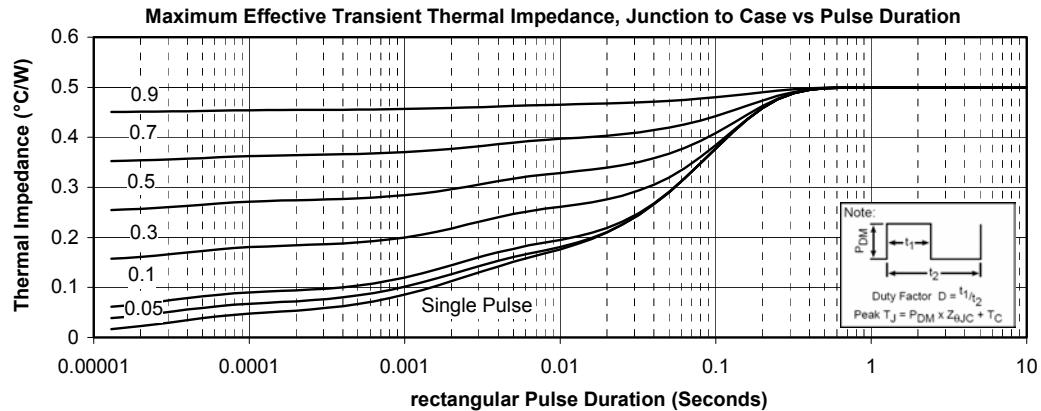


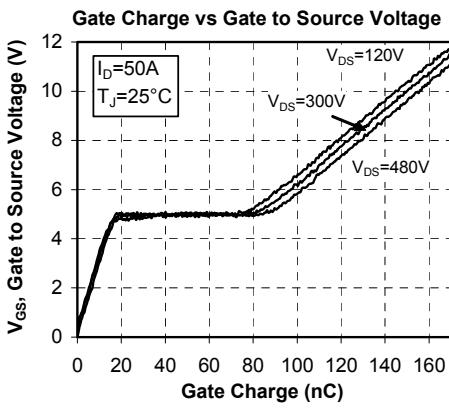
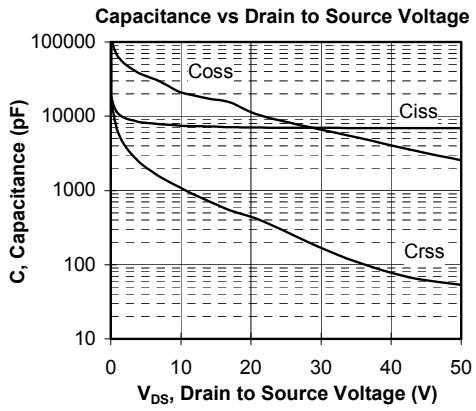
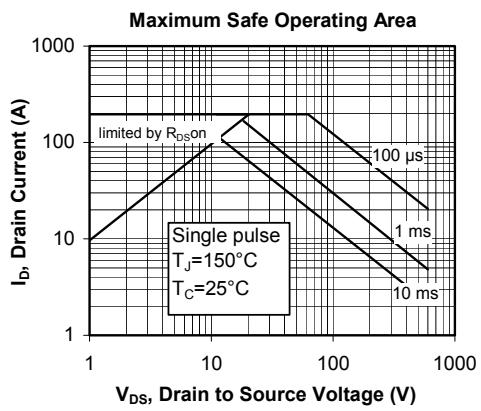
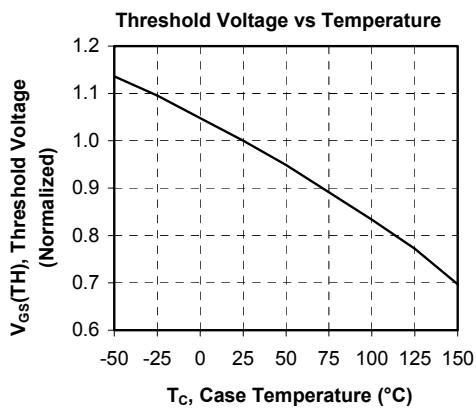
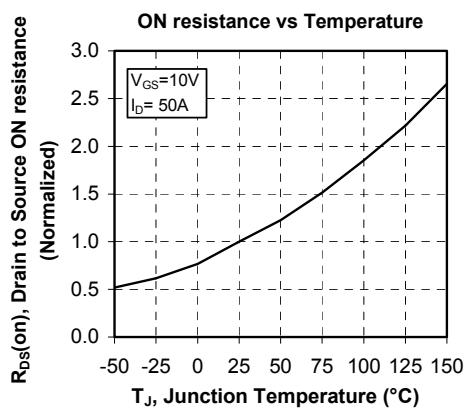
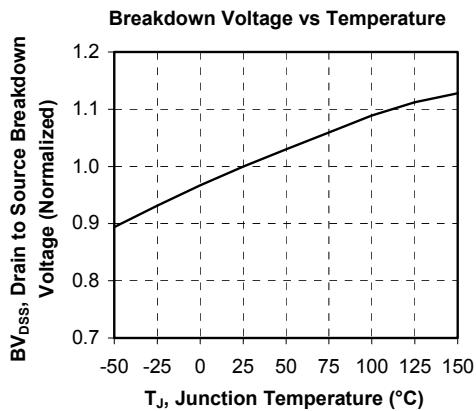
6.2 Top Fast diode typical performance curves

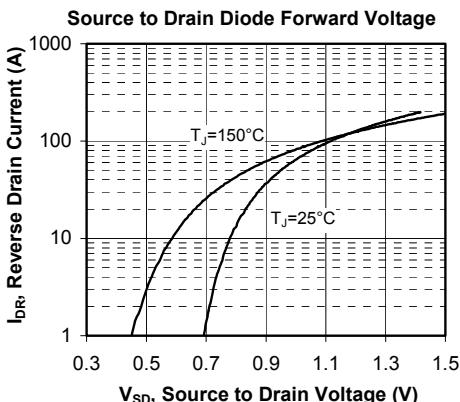
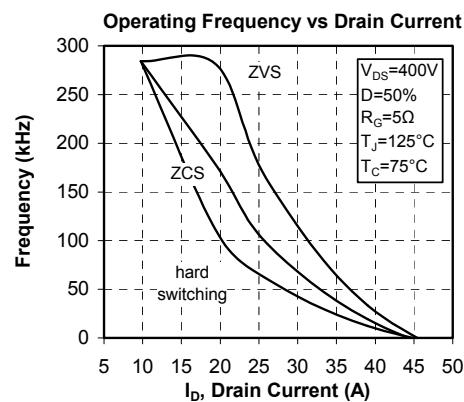
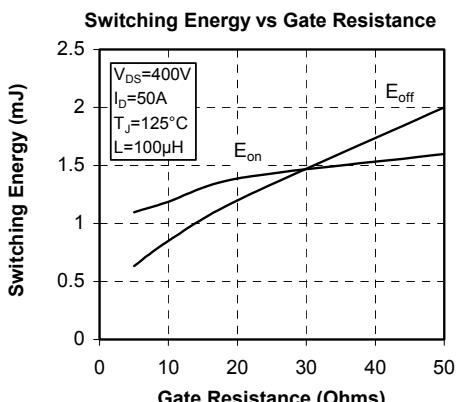
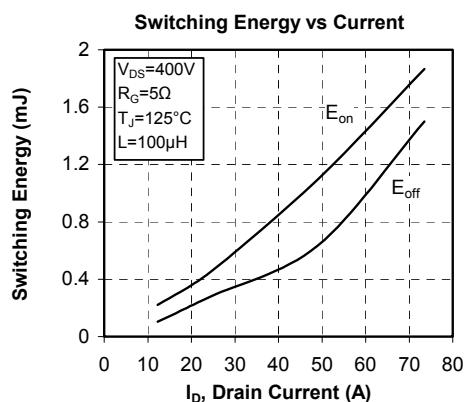
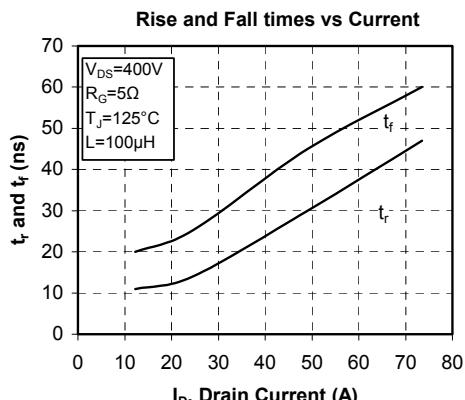
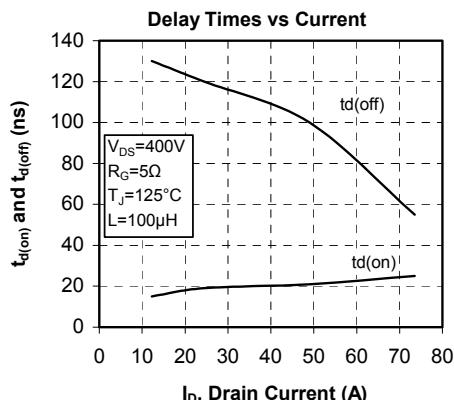


7. Bottom switches curves

7.1 Bottom CoolMOS™ typical performance curves







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